

## N-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                      |                                 |                       |  |  |  |
|---------------------|--------------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$      | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| 20                  | 0.002 at V <sub>GS</sub> = 10 V      | 46                              | 34 nC                 |  |  |  |
| 20                  | $0.0025$ at $V_{GS} = 4.5 \text{ V}$ | 41                              | 34 110                |  |  |  |

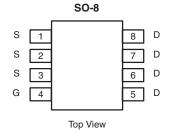
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

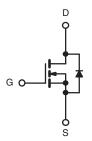
## ROHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- OR-ing
- DC/DC



Ordering Information: Si4136DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

| Parameter   | Symbol                            | Limit           | Unit                 |    |  |
|---|-----------------------------------|-----------------|----------------------|----|--|
| Drain-Source Voltage                                | $V_{DS}$                          | 20              | V                    |    |  |
| Gate-Source Voltage                                 |                                   | $V_{GS}$        | ± 20                 | v  |  |
|   | T <sub>C</sub> = 25 °C            |                 | 46                   |    |  |
| Continuous Drain Current (T <sub>.I</sub> = 150 °C) | T <sub>C</sub> = 70 °C            | I <sub>D</sub>  | 37                   |    |  |
| Continuous Diam Current (1) = 130 G)                | T <sub>A</sub> = 25 °C            | 'D              | 31 <sup>b, c</sup>   |    |  |
|   | T <sub>A</sub> = 70 °C            | 1               | 24.7 <sup>b, c</sup> | ^  |  |
| Pulsed Drain Current                                |                                   | I <sub>DM</sub> | 70                   | Α  |  |
| Continuous Source-Drain Diode Current               | T <sub>C</sub> = 25 °C            |                 | 7                    |    |  |
| Continuous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C            | Is              | 3.1 <sup>b, c</sup>  |    |  |
| Single Pulse Avalanche Current                      | L = 0.1 mH                        | I <sub>AS</sub> | 30                   |    |  |
| Avalanche Energy                                    |                                   | E <sub>AS</sub> | 45                   | mJ |  |
|   | T <sub>C</sub> = 25 °C            | P <sub>D</sub>  | 7.8                  |    |  |
| Maximum Dawar Dissination                           | T <sub>C</sub> = 70 °C            |                 | 5                    | W  |  |
| Maximum Power Dissipation                           | T <sub>A</sub> = 25 °C            |                 | 3.5 <sup>b, c</sup>  | VV |  |
|   | T <sub>A</sub> = 70 °C            | 1               | 2.2 <sup>b, c</sup>  |    |  |
| Operating Junction and Storage Temperature          | T <sub>J</sub> , T <sub>stq</sub> | - 55 to 150     | °C                   |    |  |

| THERMAL RESISTANCE RATINGS                  |              |            |         |      |              |  |  |
|---|--------------|------------|---------|------|--------------|--|--|
| Parameter                                   | Symbol       | Typical    | Maximum | Unit |              |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | $R_{thJA}$ | 29      | 35   | °C/W         |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | $R_{thJF}$ | 13      | 16   | O/ <b>VV</b> |  |  |

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 80 °C/W.

## **Si4136DY**

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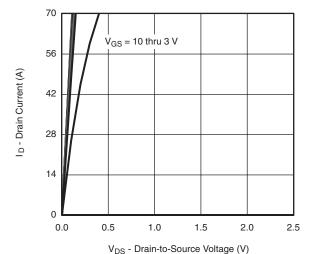
| Parameter                                     | Symbol                  | Test Conditions  | Min. | Тур.    | Max.   | Unit  |  |
|---|-------------------------|--|------|---------|--------|-------|--|
| Static  | -                       |  |      |         |        |       |  |
| Drain-Source Breakdown Voltage                | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                              | 20   |         |        | V     |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | I <sub>D</sub> = 250 μA  |      | 19      |        | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  |      | - 6     |        |       |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$                                      | 1.0  |         | 2.2    | V     |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                          |      |         | ± 100  | nA    |  |
| Zawa Cata Walkawa Dwain Cowwood               | I <sub>DSS</sub>        | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$                              |      |         | 1      | μΑ    |  |
| Zero Gate Voltage Drain Current               |                         | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ |      |         | 10     |       |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                            | 30   |         |        | Α     |  |
|   | Б                       | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A                              |      | 0.00155 | 0.002  | Ω     |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$                               |      | 0.00195 | 0.0025 |       |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A                              |      | 85      |        | S     |  |
| Dynamic <sup>b</sup>                          |                         |  |      | l.      |        |       |  |
| Input Capacitance                             | C <sub>iss</sub>        |  |      | 4560    |        | pF    |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$           |      | 1285    |        |       |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |  |      | 545     |        |       |  |
| ·   |                         | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$         |      | 73      | 110    | nC    |  |
| Total Gate Charge                             | Q <sub>g</sub>          |  |      | 34      | 50     |       |  |
| Gate-Source Charge                            | $Q_{gs}$                | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$      |      | 11      |        |       |  |
| Gate-Drain Charge                             | $Q_{gd}$                |  |      | 9       |        |       |  |
| Gate Resistance                               | $R_{g}$                 | f = 1 MHz  | 0.3  | 1.5     | 3      | Ω     |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 34      | 60     |       |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 10 V, $R_L$ = 1 $\Omega$  |      | 26      | 45     | ns    |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$                    |      | 50      | 90     |       |  |
| Fall Time                                     | t <sub>f</sub>          |  |      | 23      | 40     |       |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |      | 13      | 25     |       |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD} = 10 \text{ V}, R_L = 1 \Omega$                                    |      | 11      | 22     |       |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$           |      | 43      | 70     |       |  |
| Fall Time                                     | t <sub>f</sub>          |  |      | 9       | 18     |       |  |
| <b>Drain-Source Body Diode Characterist</b>   | cs                      |  |      |         |        |       |  |
| Continuous Source-Drain Diode Current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   |      |         | 7      | Α     |  |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>         |  |      |         | 70     |       |  |
| Body Diode Voltage                            | $V_{SD}$                | I <sub>S</sub> = 2 A   |      | 0.69    | 1.1    | V     |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |  |      | 31      | 47     | ns    |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.I</sub> = 25 °C           |      | 24      | 36     | nC    |  |
| Reverse Recovery Fall Time                    | ta                      | i <sub>F</sub> = 10 A, αί/αι = 100 Α/μ5, 1 <sub>J</sub> = 25 °C            |      | 15.5    |        |       |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |  |      | 15.5    |        | ns    |  |

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing.

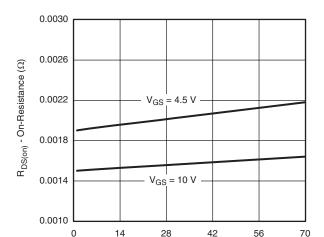
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

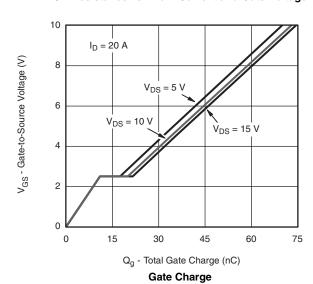


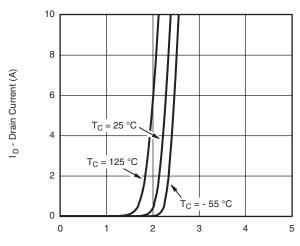
Output Characteristics



I<sub>D</sub> - Drain Current (A)

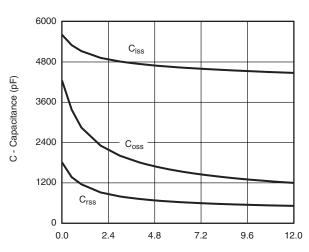
On-Resistance vs. Drain Current and Gate Voltage





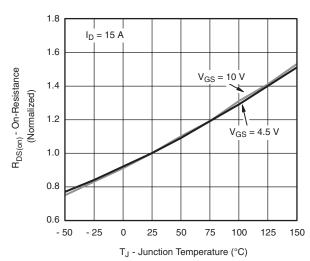
 $V_{GS}$  - Gate-to-Source Voltage (V)

#### Transfer Characteristics



V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance



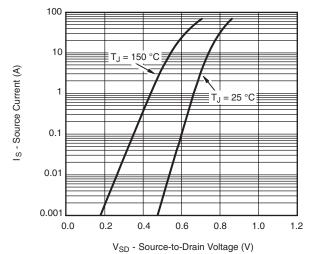
On-Resistance vs. Junction Temperature

## **Si4136DY**

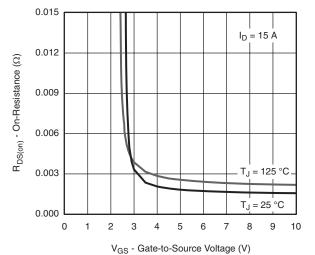
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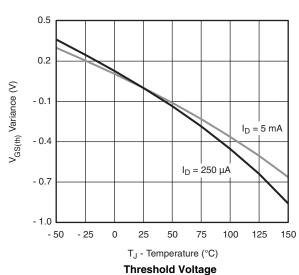
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

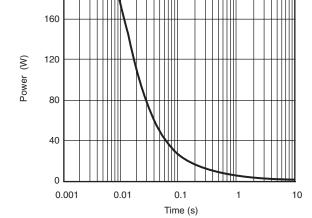


Source-Drain Diode Forward Voltage



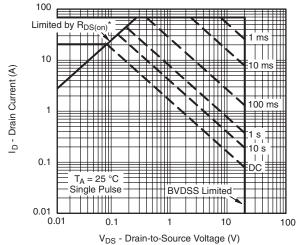
On-Resistance vs. Gate-to-Source Voltage





200

Single Pulse Power, Junction-to-Ambient

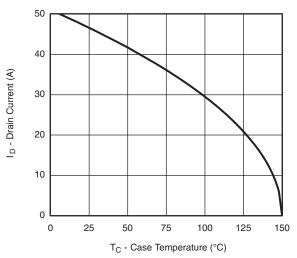


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

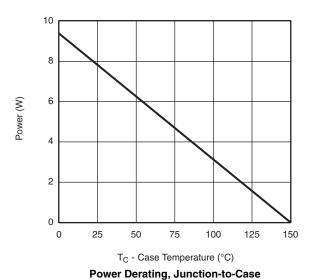
Safe Operating Area, Junction-to-Ambient

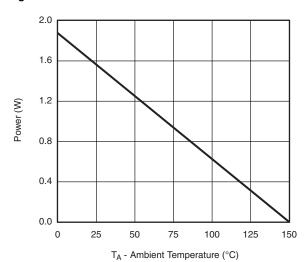


### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



### **Current Derating\***



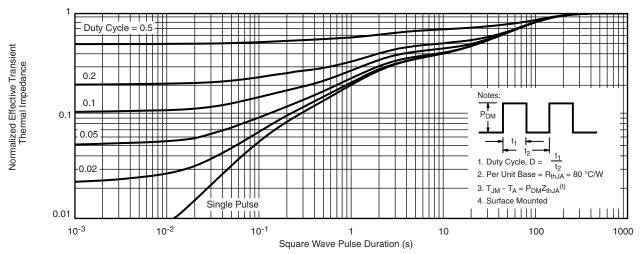


Power Derating, Junction-to-Ambient

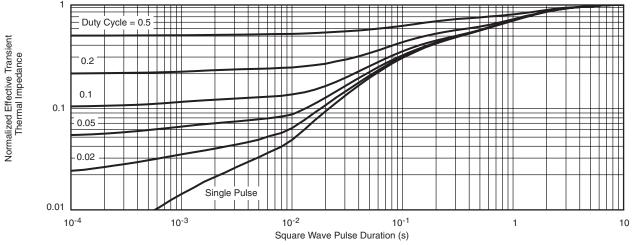
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







|                                | MILLIM | IETERS | INCHES |           |  |  |
|--------------------------------|--------|--------|--------|-----------|--|--|
| DIM                            | Min    | Max    | Min    | Max       |  |  |
| Α                              | 1.35   | 1.75   | 0.053  | 0.069     |  |  |
| A <sub>1</sub>                 | 0.10   | 0.20   | 0.004  | 0.008     |  |  |
| В                              | 0.35   | 0.51   | 0.014  | 0.020     |  |  |
| С                              | 0.19   | 0.25   | 0.0075 | 0.010     |  |  |
| D                              | 4.80   | 5.00   | 0.189  | 0.196     |  |  |
| Е                              | 3.80   | 4.00   | 0.150  | 0.157     |  |  |
| е                              | 1.27   | BSC    | 0.050  | 0.050 BSC |  |  |
| Н                              | 5.80   | 6.20   | 0.228  | 0.244     |  |  |
| h                              | 0.25   | 0.50   | 0.010  | 0.020     |  |  |
| L                              | 0.50   | 0.93   | 0.020  | 0.037     |  |  |
| q                              | 0°     | 8°     | 0°     | 8°        |  |  |
| S                              | 0.44   | 0.64   | 0.018  | 0.026     |  |  |
| ECN: C-06527-Rev. I. 11-Sep-06 |        |        |        |           |  |  |

DWG: 5498

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### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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